



Edition 2.0 2023-05 REDLINE VERSION

# INTERNATIONAL STANDARD



Printed electronics -

Part 202: Materials - Conductive ink

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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### INTERNATIONAL ELECTROTECHNICAL COMMISSION

## PRINTED ELECTRONICS -

Part 202: Materials - Conductive ink

### **FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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This redline version of the official IEC Standard allows the user to identify the changes made to the previous edition IEC 62899-202:2016. A vertical bar appears in the margin wherever a change has been made. Additions are in green text, deletions are in strikethrough red text.

IEC 62899-202 has been prepared by IEC technical committee 119: Printed electronics. It is an International Standard.

This second edition cancels and replaces the first edition published in 2016. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) definitions of conductive material, conductive ink and conductive layer have been revised;
- b) a summary of test methods is added;
- c) mechanical tests for conductive layer are added.

The text of this International Standard is based on the following documents:

Draft	Report on voting
119/423/FDIS	119/428/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

A list of all parts in the IEC 62899 series, published under the general title Printed electronics, can be found on the IEC website.

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### INTRODUCTION

The IEC 62899-20x series relates mainly to evaluation methods for materials of printed electronics. The series also include storage methods, packaging and marking, and transportation conditions.

The IEC 62899-20x series is divided into parts for each material. Each part is prepared as a generic specification containing fundamental information for the area of printed electronics.

Printed electronics is a technology that spans the printing and electrical/electronic area, and it provides a variety of products. Since participants in this industry come from different areas, their backgrounds and customs can be barriers to smooth communication and transactions in the supply chain. The printed electronics industry continues to grow, but many barriers still remain. Particularly, the lack of standardised terms and evaluation methods is one of the major factors that inhibit smooth communication.

This document focuses on measurement and evaluation methods for conductive inks and provides tools to promote the smooth communication within the supply chain.

This document specifies the basic items to be communicated and their measurement or evaluation methods. This document includes the measurement methods for the basic properties of inks and electrical conductivity, which is obtained by the post treatment of inks. Additionally, storage methods, packaging and marking, and transportation conditions are also included.

This document is part of the IEC 62899-202 series and similar documents are available for other materials used in printed electronics.

The IEC 62899-20x series consists of the following parts:

IEC 62899-201: Materials – Substrates

IEC 62899-202: Materials - Conductive ink

IEC 62899-203: Materials – Semiconductor ink<sup>4</sup>

IEC 62899-204: Materials - Insulator ink

(Subsequent parts will be prepared for other materials.)

Furthermore, sectional specifications, blank detail specifications, and detail specifications of each material will follow these parts.

This part of IEC 62899 is prepared for conductive materials used in printed electronics and contains the test conditions, the evaluation methods and the storage conditions.

<sup>&</sup>lt;sup>1</sup> Under consideration.

### PRINTED ELECTRONICS -

### Part 202: Materials - Conductive ink

### 1 Scope

This part of IEC 62899 defines the terms and specifies the standard test methods for characterization and evaluation of conductive inks.

This International Standard is applicable to conductive inks and conductive layer that are made from conductive inks.

This document also provides measurement methods for evaluating the properties of conductive layers made both from an additive process using conductive inks and from a subtractive process used in printed electronics.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62899-202-3, Printed electronics – Part 202-3: Materials – Conductive ink – Measurement of sheet resistance of conductive films – Contactless method

IEC 62899-202-5, Printed electronics – Part 202-5: Materials – Conductive ink – Mechanical bending test of a printed conductive layer on an insulating substrate

ISO 5-2, Photography and graphic technology – Density measurements – Part 2: Geometric conditions for transmittance density

ISO 5-3, Photography and graphic technology – Density measurements – Part 3: Spectral conditions

ISO 124, Latex, rubber - Determination of total solids content

ISO 291, Plastics - Standard atmospheres for conditioning and testing

ISO 304, Surface active agents – Determination of surface tension by drawing up liquid films

ISO 489:<del>1999</del>2022, *Plastics – Determination of refractive index* 

ISO 758, Liquid chemical products for industrial use – Determination of density at 20 degrees C

ISO 1183-1, Plastics – Methods for determining the density of non-cellular plastics – Part 1: Immersion method, liquid pycnometer method and titration method

ISO 2409:2020, Paints and varnishes – Cross-cut test

ISO 2471, Paper and board – Determination of opacity (paper backing) – Diffuse reflectance method

ISO 2555, Plastics – Resins in the liquid state or as emulsions or dispersions – Determination of apparent viscosity by the Brookfield Test using a single cylinder type rotational viscometer method

ISO 2592, Petroleum and related products – Determination of flash and fire points – Cleveland open cup method

ISO 2719, Determination of flash point – Pensky-Martens closed cup method

ISO 2811-1, Paints and varnishes – Determination of density – Part 1: Pycnometer method

ISO 2811-2, Paints and varnishes – Determination of density – Part 2: Immersed body (plummet) method

ISO 2884-1, Paints and varnishes – Determination of viscosity using rotary viscometers – Part 1: Cone-and-plate viscometer operated at a high rate of shear

ISO 3219, Plastics – Polymers/resins in the liquid state or as emulsions or dispersions – Determination of viscosity using a rotational viscometer with defined shear rate

ISO 3251, Paints, varnishes and plastics – Determination of non-volatile-matter content

ISO 3451-1, Plastics – Determination of ash – Part 1: General methods

ISO 3664, Graphic technology and photography – Viewing conditions

ISO 3679, Determination of flash no-flash and flash point – Rapid equilibrium closed cup method

ISO 4576, Plastics – Polymer dispersions – Determination of sieve residue (gross particle and coagulum content)

ISO 9276-6, Representation of results of particle size analysis – Part 6: Descriptive and quantitative representation of particle shape and morphology

ISO 11664-4, Colorimetry – Part 4: CIE 1976 L\*a\*b\* colour space

ISO 13319, Determination of particle size distributions – Electrical sensing zone method

ISO 13320, Particle size analysis – Laser diffraction methods

ISO 13321, Particle size analysis – Photon correlation spectroscopy

ISO 13322-1, Particle size analysis – Image analysis methods – Part 1: Static image analysis methods

ISO 13468-1:<del>1996</del>2019, Plastics – Determination of the total luminous transmittance of transparent materials – Part 1: Single beam instrument

ISO 13468-2:<del>1999</del>2021, Plastics – Determination of the total luminous transmittance of transparent materials – Part 2: Double-beam instrument

ISO 13655, Graphic technology – Spectral measurement and colorimetric computation for graphic arts images

ISO 14488, Particulate materials – Sampling and sample splitting for the determination of particulate properties

ISO 14782, Plastics – Determination of haze for transparent materials

ISO 14887, Sample preparation – Dispersing procedures for powders in liquids

ISO 15212-1, Oscillation-type density meters – Part 1: Laboratory instruments

ISO 18947-1:2021, Imaging materials and prints – Abrasion resistance – Part 1: General rub testing methods

ISO 20379, Fine ceramics (advanced ceramics, advanced technical ceramics) – Measurement of thixotropic behaviour of ceramic slurry by use of a rotational viscometer

ISO 20998-1, Measurement and characterization of particles by acoustic methods – Part 1: Concepts and procedures in ultrasonic attenuation spectroscopy



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ISO 14782, Plastics – Determination of haze for transparent materials

ISO 14887, Sample preparation – Dispersing procedures for powders in liquids

ISO 15212-1, Oscillation-type density meters – Part 1: Laboratory instruments

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ISO 20379, Fine ceramics (advanced ceramics, advanced technical ceramics) – Measurement of thixotropic behaviour of ceramic slurry by use of a rotational viscometer

ISO 20998-1, Measurement and characterization of particles by acoustic methods – Part 1: Concepts and procedures in ultrasonic attenuation spectroscopy